



Product End-of-Life Disassembly Instructions

Product Category: Networking Equipment

Marketing Name / Model

[List multiple models if applicable.]

HP ProCurve 3500yl-48G PoE+ Switch (J9311A)

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

| Item Description | Notes | Quantity of items included in product |
|--|---|---------------------------------------|
| Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA) | With a surface greater than 10 sq cm PCA, DB24-2, POE+ (5070-6387) - 1no. PCA, Aragon-2 power supply PCA(DCJ6602-05P) - 1no. PCB, Moccasin (5092-1789) -1no. PCA, Console CR RoHS (5070-2156) -1no. | 4 |
| Batteries | All types including standard alkaline and lithium coin or button style batteries BR2032 | 1 |
| Mercury-containing components | For example, mercury in lamps, display backlights, scanner lamps, switches, batteries Nil | 0 |
| Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm | Includes background illuminated displays with gas discharge lamps Nil | 0 |
| Cathode Ray Tubes (CRT) | Nil | 0 |
| Capacitors / condensers (Containing PCB/PCT) | Nil | 0 |
| Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height | used in Aragon-2(DCJ6602-05P) power supply | 2 |
| External electrical cables and cords | Power cord, Console cable | 2 |
| Gas Discharge Lamps | Nil | 0 |
| Plastics containing Brominated Flame Retardants | Nil | 0 |
| Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner | Include the cartridges, print heads, tubes, vent chambers, and service stations. Nil | 0 |
| Components and waste containing asbestos | Nil | 0 |

| | | |
|--|-----|---|
| Components, parts and materials containing refractory ceramic fibers | Nil | 0 |
| Components, parts and materials containing radioactive substances | Nil | 0 |

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

| Tool Description | Tool Size (if applicable) |
|-------------------------|---------------------------|
| Torx driver (standard) | T10, T15 & T20 |
| Small adjustable wrench | 5mm |
| Wire cutter | Medium |
| Hexagonal socket | 3/16" |

3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Unfasten two captive screws from chassis and remove the Pygmy Module (if Applicable)
2. Unfasten all the screws that are fasten to the top cover with the chassis
3. Remove top cover.then remove the cover of PowerDevice (Aragon-2)
4. Disconnect the cable which is connected with PCA moccasin.
5. Unfasten the three screws from PCA,Moccasin and remove it.
6. Disconnect all the cables.
7. Remove the screws that fasten the grounding lug to the chassis.
8. Unfasten the two screws from baffle and remove it.
9. Unfasten two screws from PCA,Diamond eye and remove it
10. Remove all the screws/stand off that are fasten to the Power device(Aragon-2) and Main PCA in the Chassis base.
11. Unfasten the SCREW LOCK KIT-AMP HD which are used to fasten the EPS/RPS connectors.
12. Remove the PowerDevice (Aragon-2)
13. Remove the PowerDevice(Aragon-2) insulator.
14. Unfasten two screws from PCA Console and remove it.
15. Unfasten one screw from the fan tray and remove the fan tray assembly.
16. Remove the Light pipe
17. Then,remove the Main PCA.
18. Disassemble the Front flap from the chassis
- 19.

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

